#### NCE N-Channel Enhancement Mode Power MOSFET

#### **Description**

The NCE75H21 uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in Automotive applications and a wide variety of other applications.

#### **General Features**

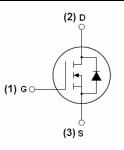
- $V_{DSS} = 75V, I_D = 210A$  $R_{DS(ON)} < 4m\Omega @ V_{GS} = 10V$
- Good stability and uniformity with high E<sub>AS</sub>
- Special process technology for high ESD capability
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

### **Application**

- Automotive applications
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!



#### Schematic diagram



#### Marking and pin assignment



TO-220-3L top view

#### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE75H21	NCE75H21	TO-220	-	-	-

## Absolute Maximum Ratings (TC=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDSS	75	V
Gate-Source Voltage	V <sub>G</sub> s	±20	V
Drain Current-Continuous	I <sub>D</sub>	210	А
Drain Current-Continuous(T <sub>C</sub> =100°C)	I <sub>D</sub> (100℃)	150	Α
Pulsed Drain Current	I <sub>DM</sub>	840	Α
Maximum Power Dissipation	P <sub>D</sub>	310	W
Derating factor		2.07	W/℃
Single pulse avalanche energy (Note 4)	E <sub>AS</sub>	2200	mJ



Thermal Resistance,Junction-to-Case (Note 1)

# **NCE75H21**

°C/W

0.48

Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 175	$^{\circ}$ C
Thermal Characteristic			

 $R_{\theta JC}$ 

Electrical Characteristics (T<sub>C</sub>=25°C unless otherwise noted)

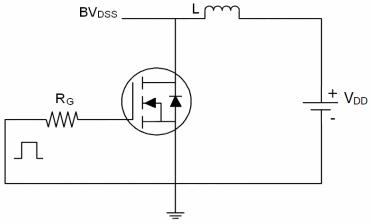
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	<u>.</u>					
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	75			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =75V,V <sub>GS</sub> =0V			1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V			±200	nA
On Characteristics						•
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	2	3	4	V
Drain-Source On-State Resistance	5°C Rayou	V <sub>GS</sub> =10V, I <sub>D</sub> =40A		2.8	4	mΩ
	R <sub>DS(ON)</sub>	VGS-10V, 1D-40A		4.7	6.5	mΩ
Forward Transconductance	<b>g</b> FS	$V_{DS}$ =25 $V$ , $I_{D}$ =40 $A$	100	165		S
Dynamic Characteristics						
Input Capacitance	C <sub>lss</sub>	\/ -05\/\/ -0\/		11000		PF
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ =25V, $V_{GS}$ =0V, F=1.0MHz		914		PF
Reverse Transfer Capacitance	C <sub>rss</sub>	r-1.0ivinz		695		PF
Switching Characteristics						
Turn-on Delay Time	t <sub>d(on)</sub>			23		nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =30 $V$ , $I_D$ =2 $A$ , $R_L$ =15 $\Omega$		190		nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10 $V$ , $R_{G}$ =2.5 $\Omega$		130		nS
Turn-Off Fall Time	t <sub>f</sub>			120		nS
Total Gate Charge	Qg		-	250		nC
Gate-Source Charge	Q <sub>gs</sub>	I <sub>D</sub> =30A,V <sub>DD</sub> =30V,V <sub>GS</sub> =10V	-	48		nC
Gate-Drain Charge	$Q_{gd}$		-	98		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =40A			1.2	V
Reverse Recovery Time	t <sub>rr</sub>	TJ = 25°C, IF = 40A		63		nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs <sup>(Note2)</sup> 98		nC		
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				
	•					

#### Notes:

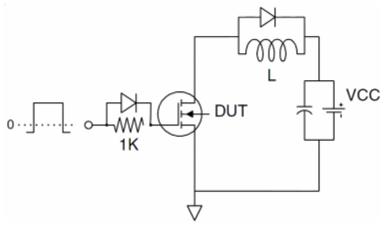
- 1. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 2. Pulse Test: Pulse Width  $\leq 400 \mu s,$  Duty Cycle  $\leq 2\%.$
- 3. EAS condition: Tj=25°C,VDD=37.5V,VG=10V,L=2mH,Rg=25 $\Omega$ ,IAS=37A

## **Test circuit**

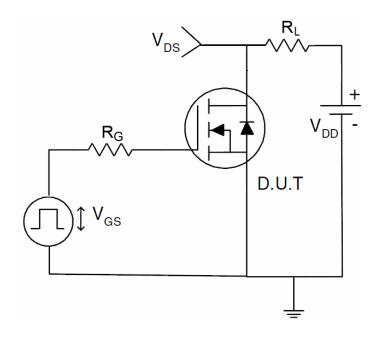
# 1) E<sub>AS</sub> test Circuit



## 2) Gate charge test Circuit



#### 3) Switch Time Test Circuit





## **Typical Electrical and Thermal Characteristics**

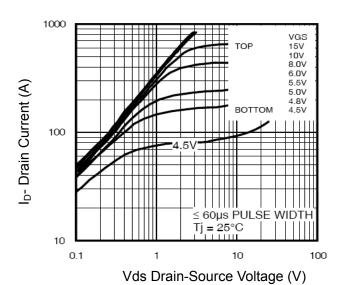
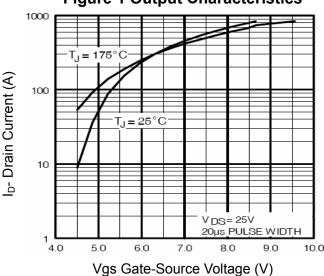


Figure 1 Output Characteristics



**Figure 2 Transfer Characteristics** 

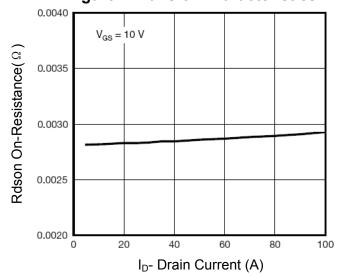


Figure 3 Rdson- Drain Current

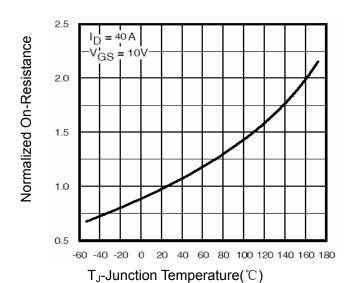


Figure 4 Rdson-JunctionTemperature

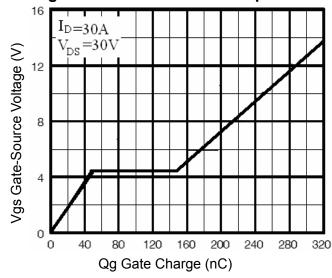


Figure 5 Gate Charge

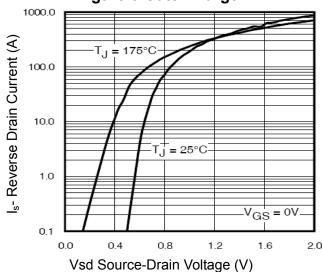


Figure 6 Source- Drain Diode Forward



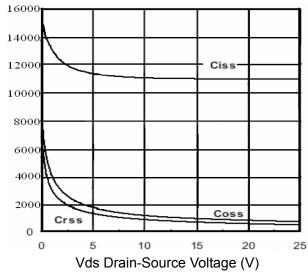


Figure 7 Capacitance vs Vds

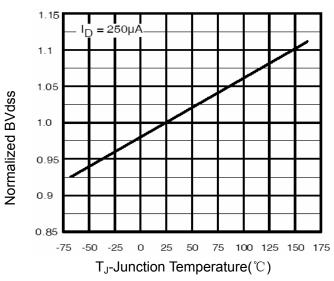


Figure 9 BV<sub>DSS</sub> vs Junction Temperature

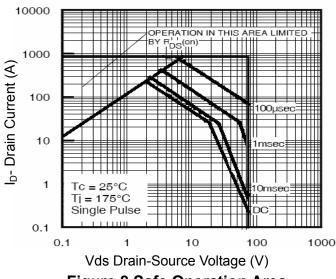


Figure 8 Safe Operation Area

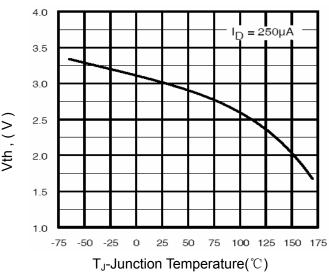


Figure 10 V<sub>GS(th)</sub> vs Junction Temperature

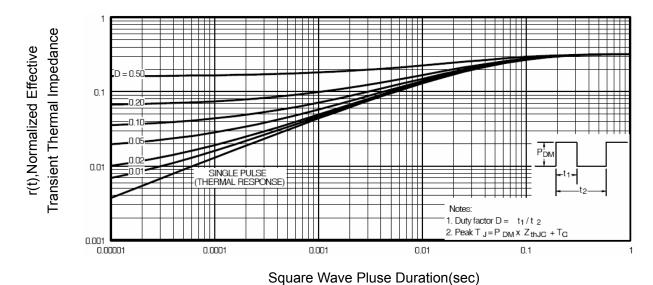
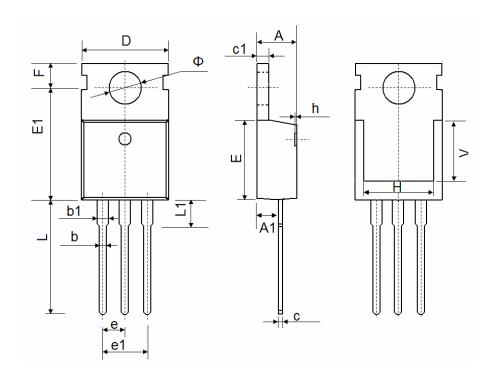


Figure 11 Normalized Maximum Transient Thermal Impedance

# **TO-220-3L Package Information**



Cumbal	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
Е	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.54	0 TYP.	0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	7.50	7.500 REF.		REF.	
Ф	3.400	3.800	0.134	0.150	

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